

FIGURE 1

22-11 50 SHEETS
22-12 100 SHEETS
22-14 200 SHEETS

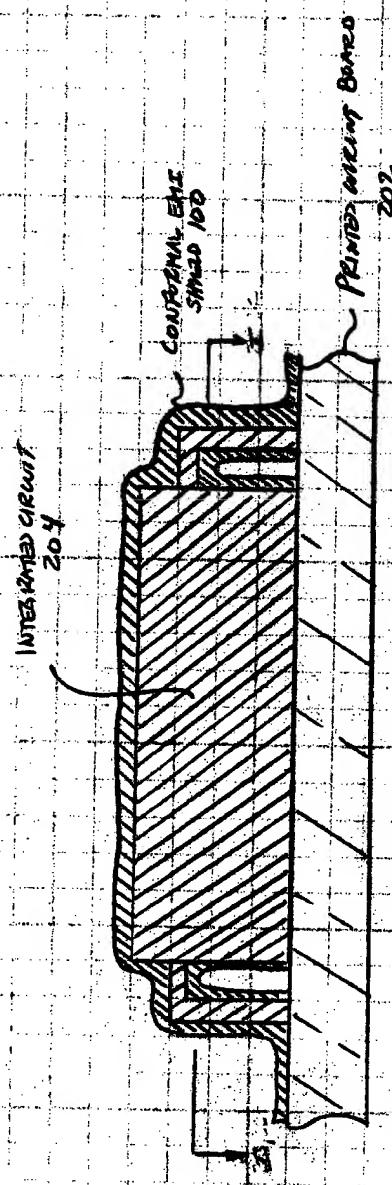


Figure 2A

 22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

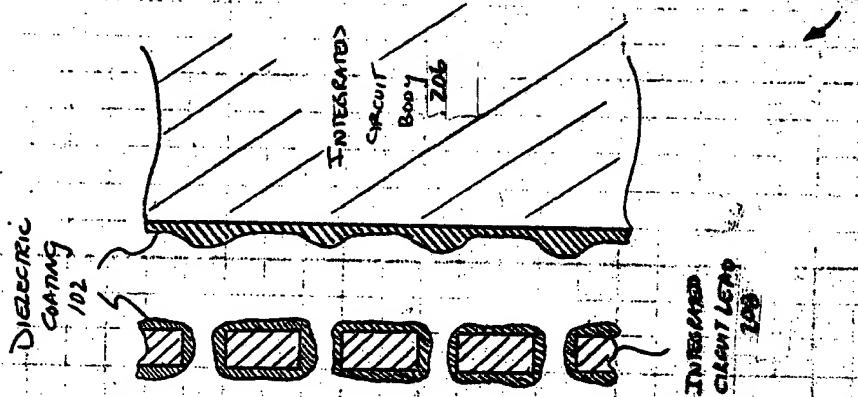


Figure 2B

22-142
22-144
100-144
50-144
200-144

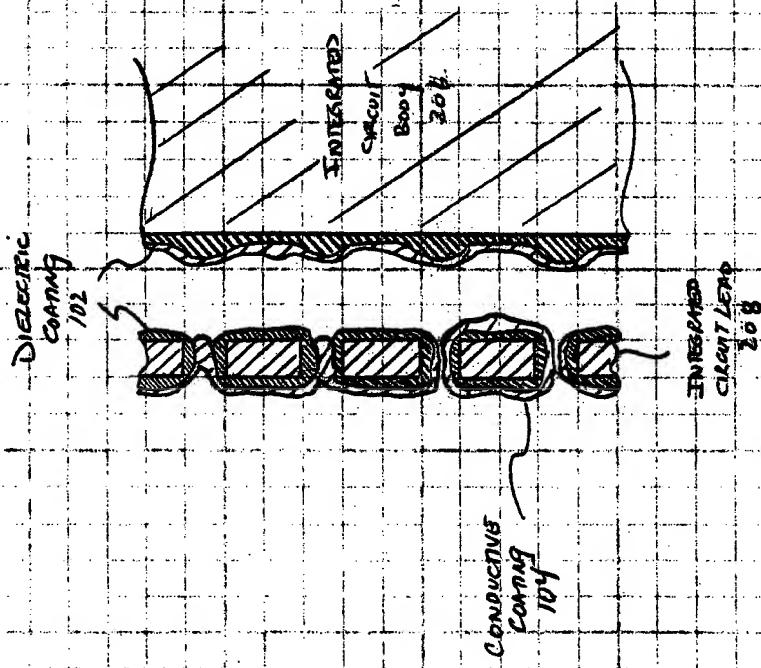


Figure 28

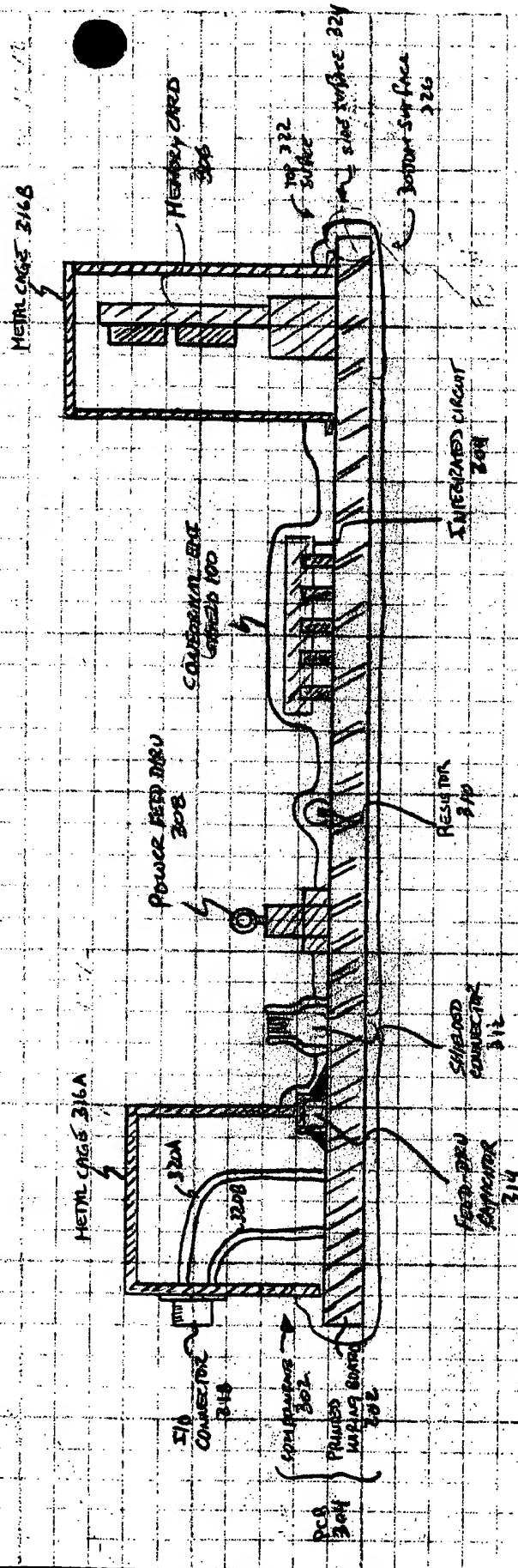


FIGURE 3.



22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

AWARD
22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

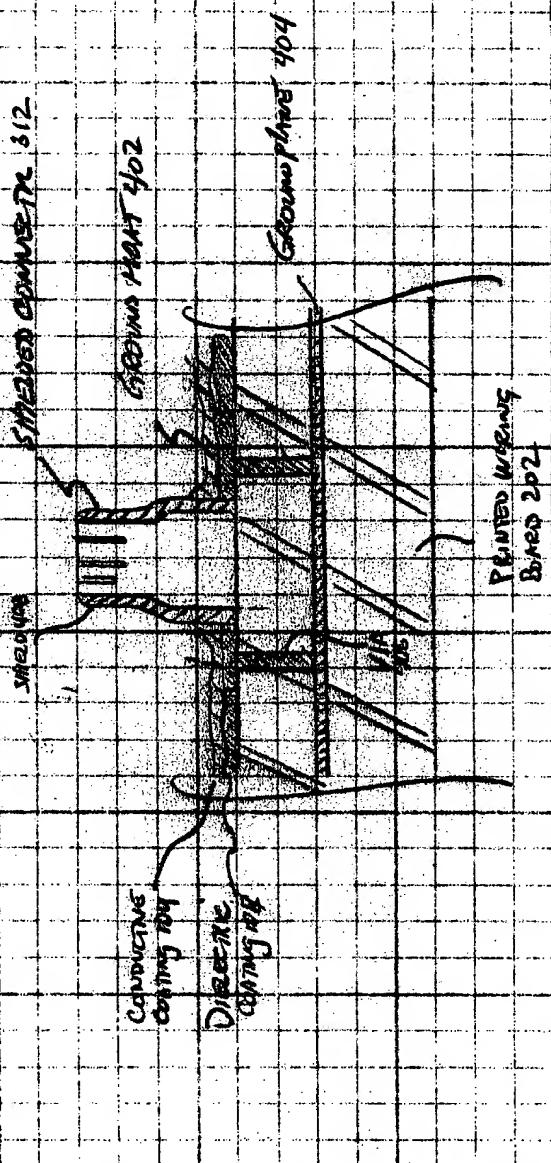


Figure 4

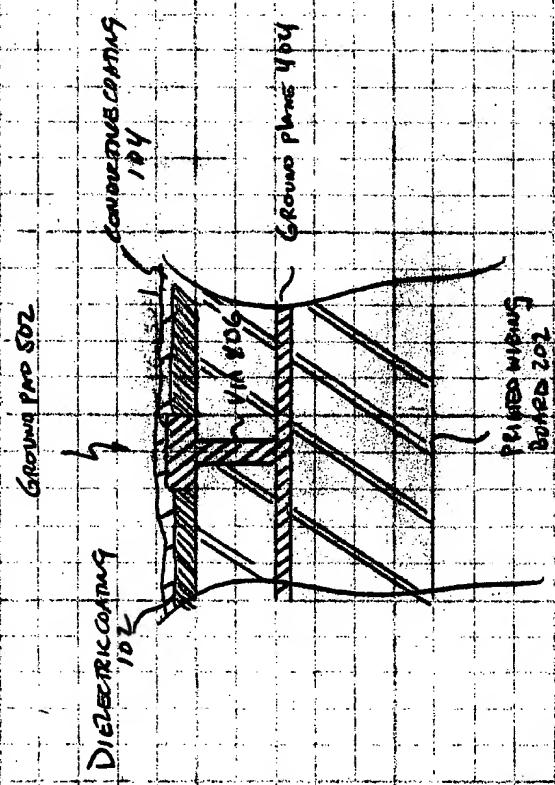


Figure 5



22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS



Printed Writing
BOARD
202

Dielectric
Coating 102

Conductive Coating
104

Conformal Enclosure 100

Aluminum Enclosure 324

FIGURE 6A

Conductive Coating
104

Ground Plane 100

Conformal Enclosure 100

Aluminum Enclosure 324

Ground Plane 100

Enclosure
100

Printed Writing Board

202

FIGURE 6B

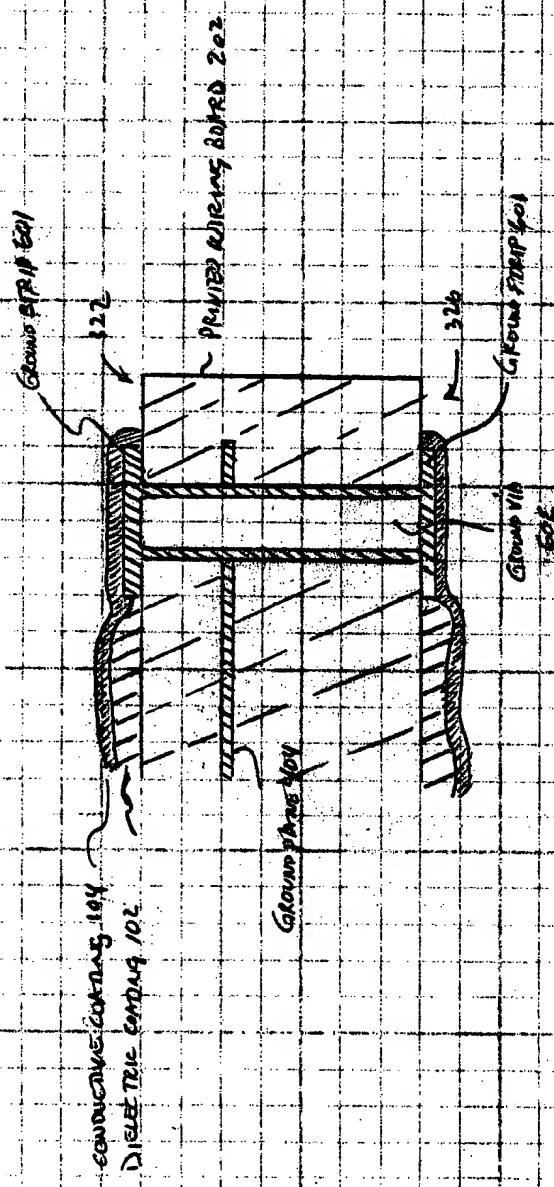
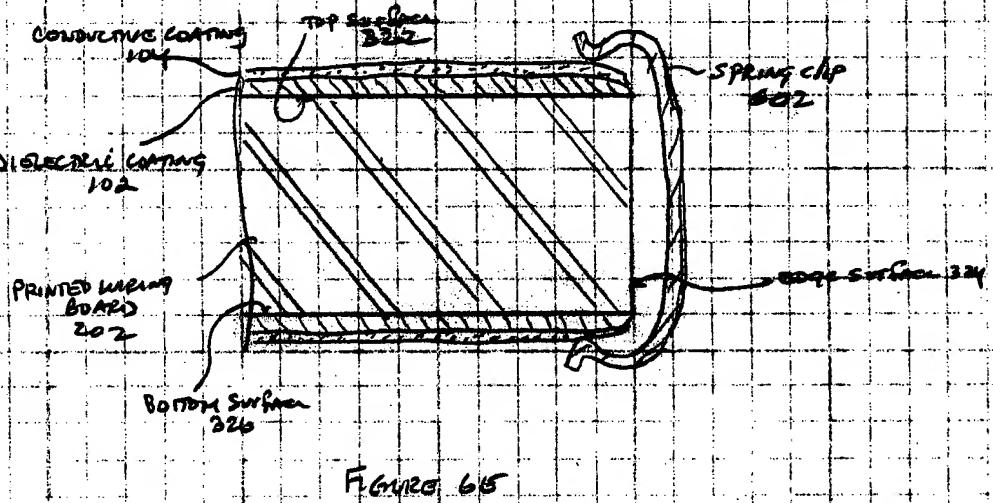
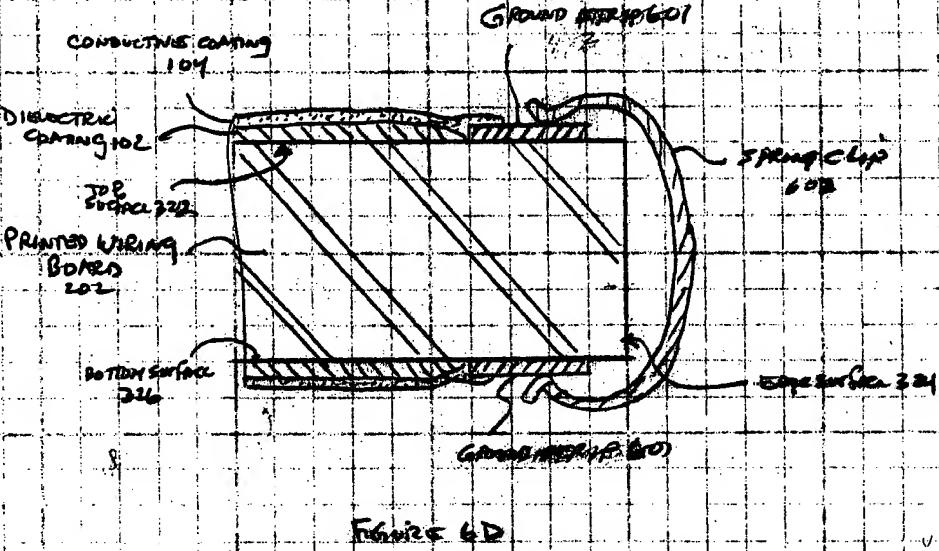


Figure 6c

22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS



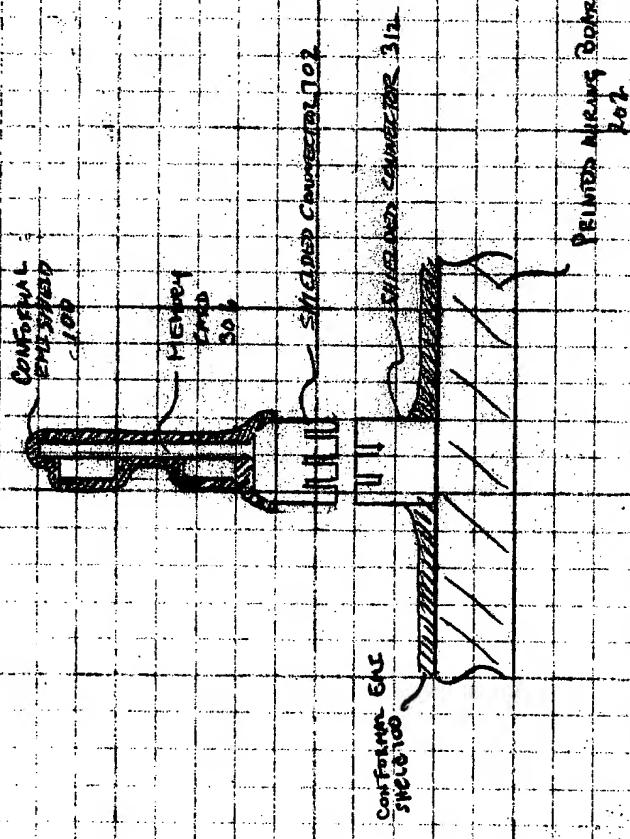


Figure 9

 22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

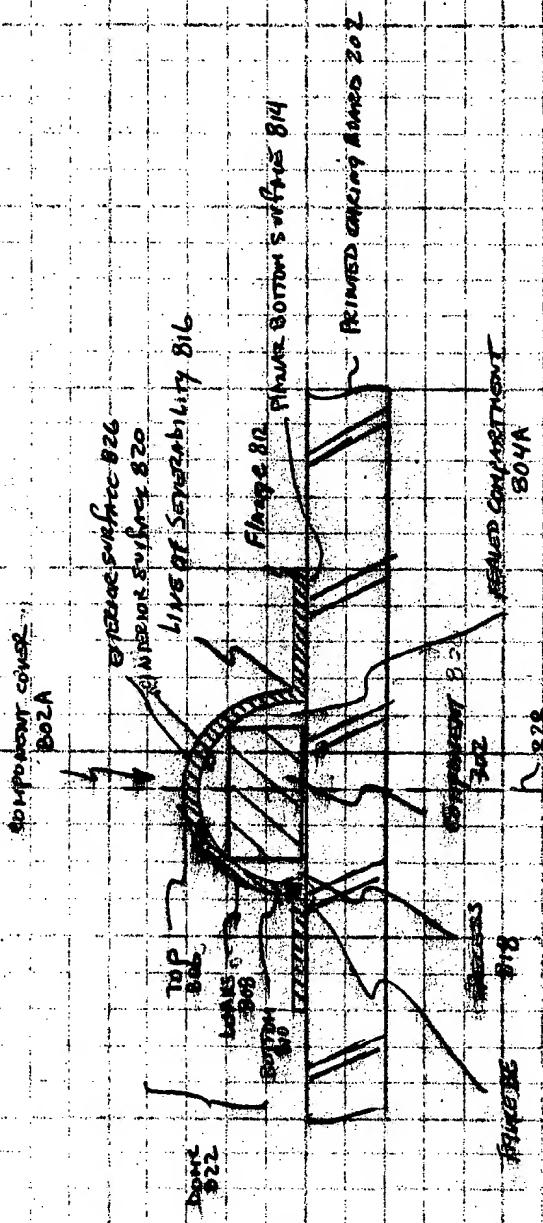


Figure 3A

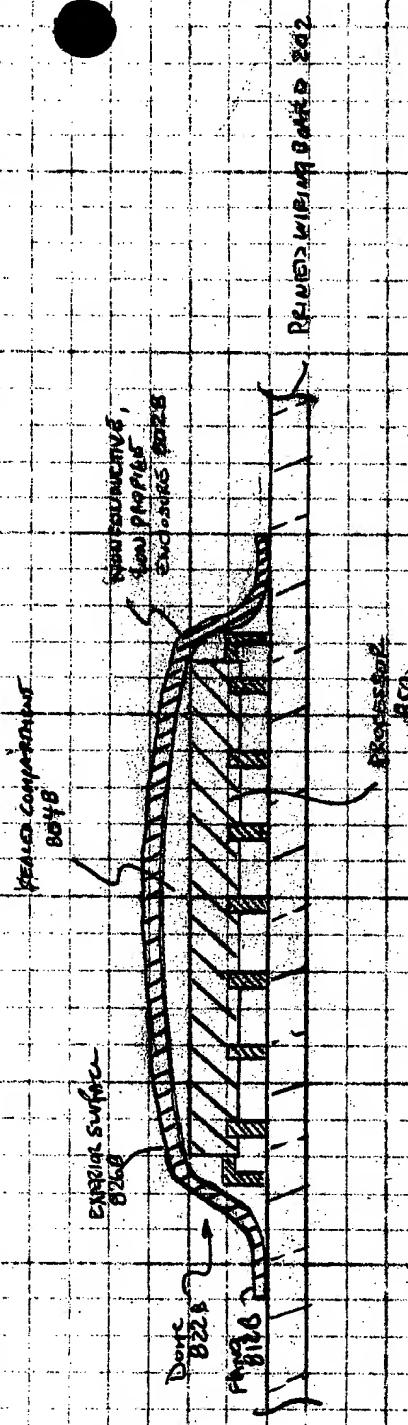
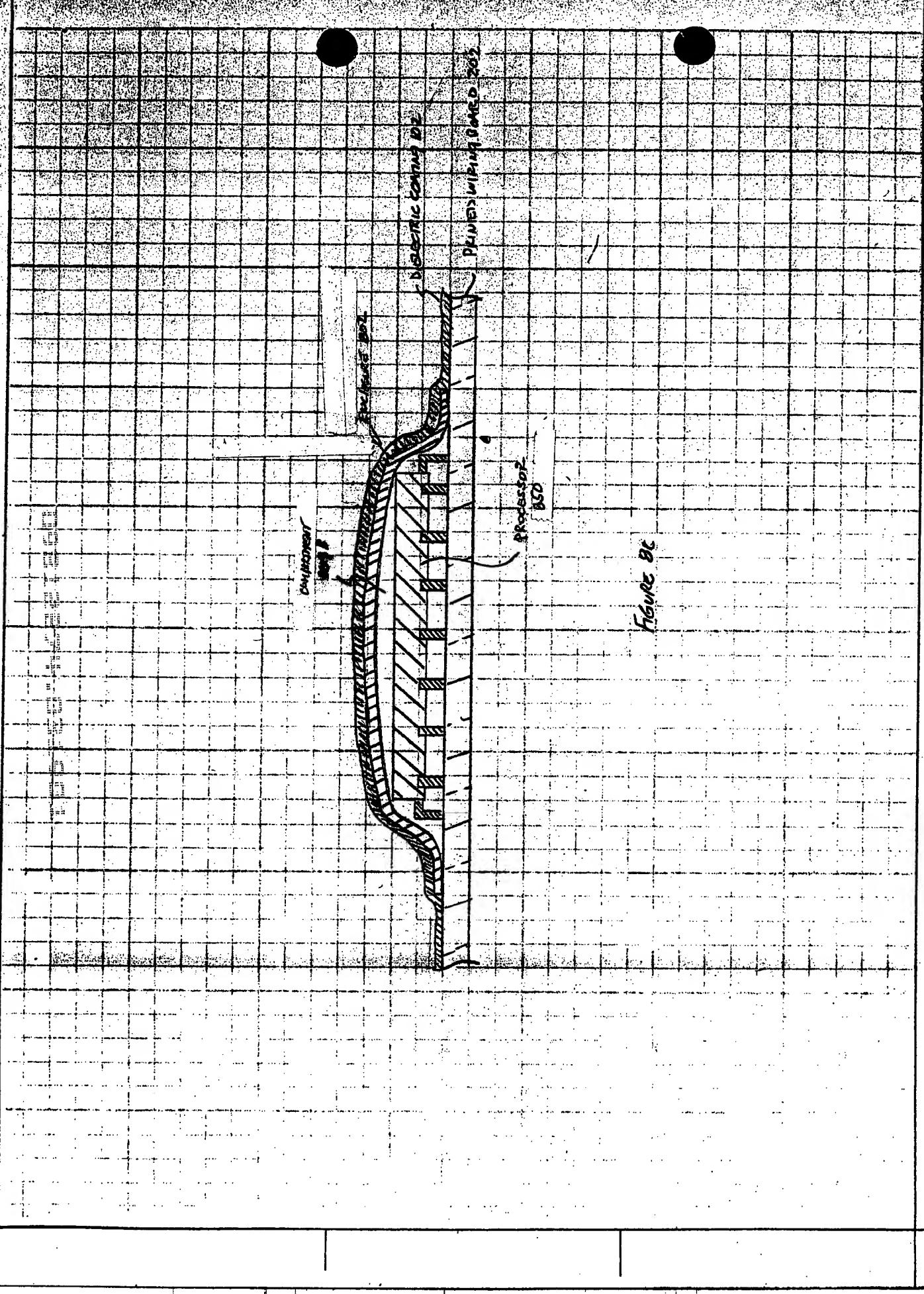


Figure 88



AMRAD
22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

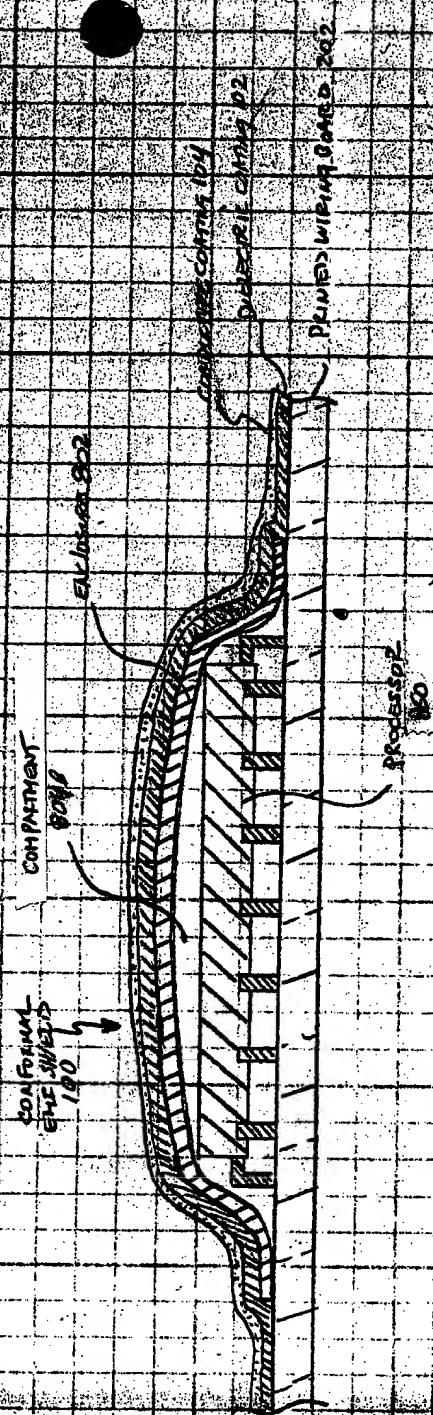


Figure 8D

AMERICAN
22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

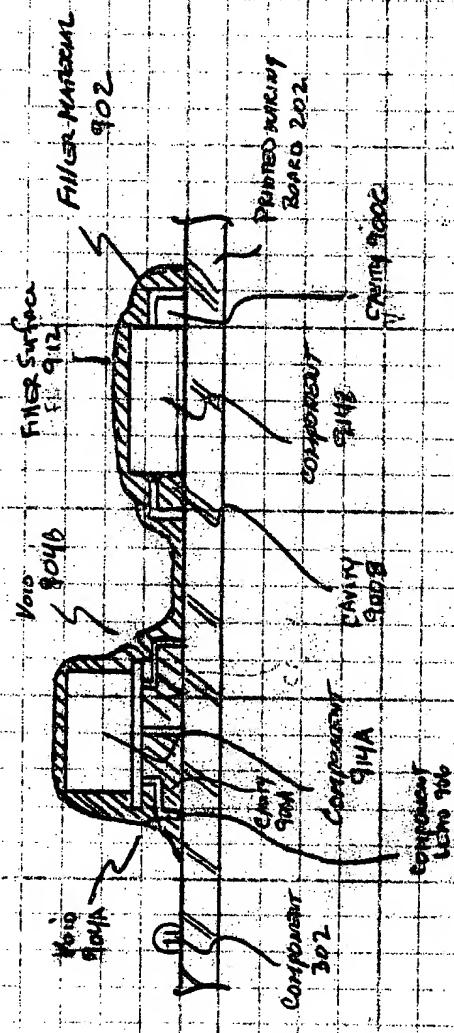


Figure 9A

22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

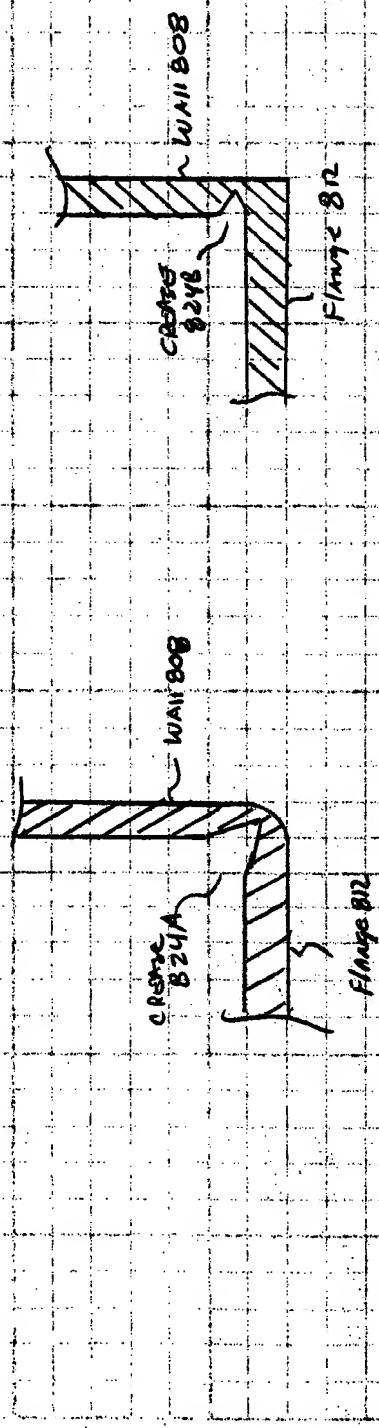


Figure 8E-1

Figure 8E-2

Figure 8E

Common Lutu 9058
Common Lutu 9058

Female
902

Female
902
Male
902

Figure 9B



22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS

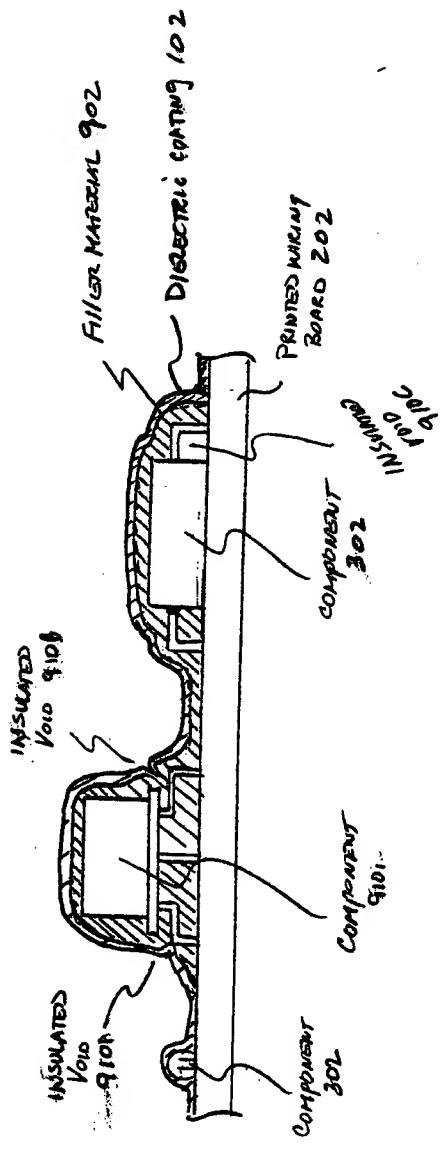


Figure 9c



22-141	50 SHEETS
22-142	100 SHEETS
22-144	200 SHEETS

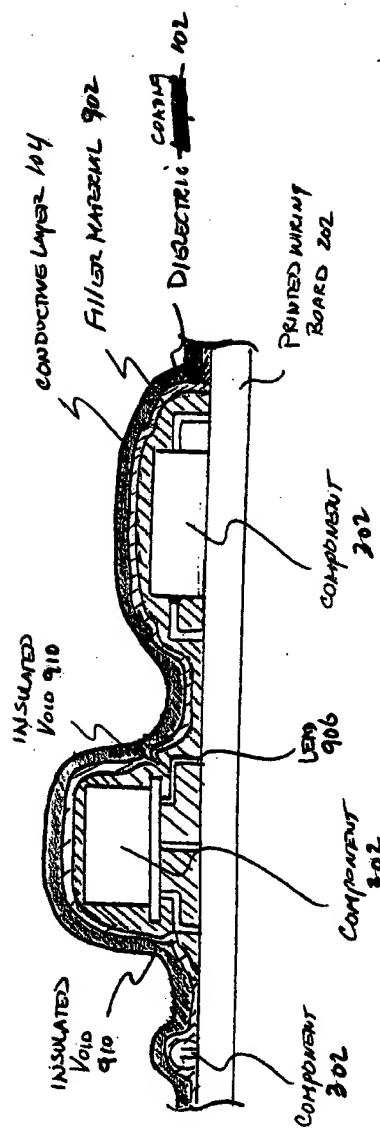


FIGURE 9D

22-141 50 SHEETS
22-142 100 SHEETS
22-144 200 SHEETS



PRINTED CIRCUIT BOARD ASSEMBLY

Conduct Pattern Wires Board ~1002

Populate Pattern Wires Board ~1004

Prepare Printed Circuit Board ~1006

Cover Interconnect Spaces with Fibre ~1008

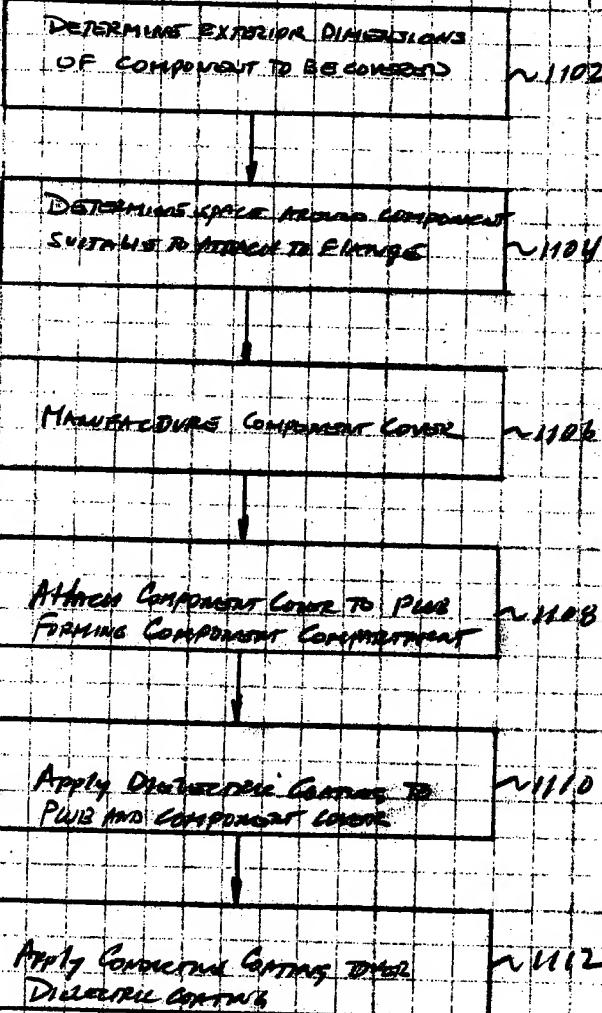
MATERIAL

Mount Component Centers ~1010

Apply Desolderization ~1012

Apply Conductive Coating ~1014

Figure 18



FIGURES 11